

EGP30A - EGP30K

Features

- Glass passivated cavity-free junction.
- High surge current capability.
- Low leakage current.
- · Superfast recovery time for high efficiency.
- Low forward voltage, high current capability.



DO-201AD COLOR BAND DENOTES CATHODE

Fast Rectifiers (Glass Passivated)

Absolute Maximum Ratings* T_A = 25°C unless otherwise noted

Symbol	Parameter	Value								Units
		30A	30B	30C	30D	30F	30G	30J	320	
V_R	Breakdown Voltage		100	150	200	300	400	600	800	V
I _{F(AV)}	Average Rectified Forward Current, .375 " lead length @ T _A = 55°C		3.0							А
I _{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave		125						Α	
T _{stg}	Storage Temperature Range		-65 to +150							°C
T _J	Operating Junction Temperature		-65 to +150							°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P _D	Power Dissipation	6.25	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	20	°C/W
$R_{\theta JL}$	Thermal Resistance, Junction to Lead	8.5	°C/W

Electrical Characteristics T_A = 25°C unless otherwise noted

Symbol	Parameter		Device							
			30B	30C	30D	30F	30G	30J	320	
V _F	Forward Voltage @ 3.0 A		0.95			1.25		1.7		V
t _{rr}	Reverse Recovery Time $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	50					75		ns	
I _R	Reverse Current @ rated V_R $T_A = 25^{\circ}C$ $T_A = 125^{\circ}C$		5.0 100							μΑ μΑ
Ст	Total Capacitance V _R = 4.0 V, f = 1.0 MHz		95			75				pF

Typical Characteristics

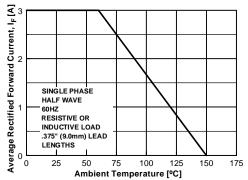
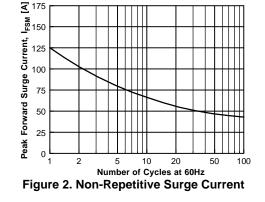


Figure 1. Forward Current Derating Curve



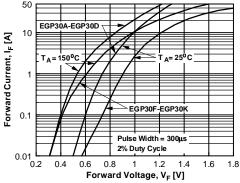


Figure 3. Forward Voltage Characteristics

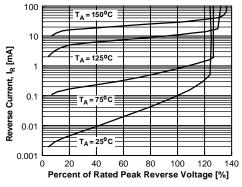


Figure 4. Reverse Current vs Reverse Voltage

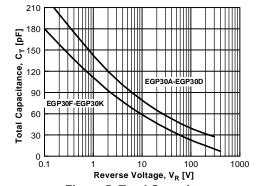
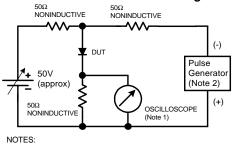
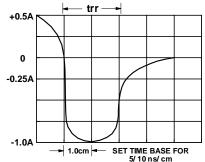


Figure 5. Total Capacitance



1. Rise time = 7.0 ns max; Input impedance = 1.0 megaohm 22 pf. 2. Rise time = 10 ns max; Source impedance = 50 ohms.



Reverse Recovery Time Characterstic and Test Circuit Diagram

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